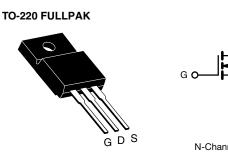
SiHF10N40D



Vishay Siliconix

D Series Power MOSFET



PRODUCT SUMMA	RY	
V _{DS} (V) at T _J max.	450)
R _{DS(on)} max. (Ω) at 25 °C	$V_{GS} = 10 V$	0.6
Q _g max. (nC)	30	
Q _{gs} (nC)	4	
Q _{gd} (nC)	7	
Configuration	Sing	le

FEATURES

- Optimal design
 - Low area specific on-resistance
 - Low input capacitance (C_{iss})
 - Reduced capacitive switching losses
 - High body diode ruggedness
 - Avalanche energy rated (UIS)
- · Optimal efficiency and operation
 - Low cost
 - Simple gate drive circuitry
 - Low figure-of-merit (FOM): Ron x Qa
 - Fast switching
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

Note

* This datasheet provides information about parts that are RoHS-compliant and / or parts that are non-RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details.

APPLICATIONS

- Consumer electronics
- Displays (LCD or plasma TV)
- Server and telecom power supplies
- SMPS
- Industrial
 - Welding
 - Induction heating
 - Motor drives
- Battery chargers

ORDERING INFORMATION	
Package	TO-220 FULLPAK
Lead (Pb)-free	SiHF10N40D-E3

PARAMETER		SYMBOL	LIMIT	UNIT
Drain-Source Voltage		V _{DS}	400	
Gate-Source Voltage		N/	± 30	V
Gate-Source Voltage AC (f > 1 Hz)		V _{GS}	30	
Continuous Drain Current (T 150 °C) 8	V_{GS} at 10 V $T_C = 25 \degree C$ $T_C = 100 \degree C$	I	10	
Continuous Drain Current ($T_J = 150 \ ^\circ C$) $^\circ$	$T_{\rm GS}$ at 10 V $T_{\rm C} = 100 ^{\circ}{\rm C}$	I _D	6	А
Pulsed Drain Current ^a		I _{DM}	23	
Linear Derating Factor			0.26	W/°C
Single Pulse Avalanche Energy ^b		E _{AS}	194	mJ
Maximum Power Dissipation		PD	33	W
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to +150	°C
Drain-Source Voltage Slope	T _J = 125 °C	d\//d+	24	1//20
Reverse Diode dV/dt ^d		dV/dt	0.6	V/ns
Soldering Recommendations (Peak temperature) ^c	For 10 s		300	°C
Mounting Torque	M3 screw		0.6	Nm

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b. V_{DD} = 50 V, starting T_J = 25 °C, L = 2.3 mH, R_g = 25 Ω , I_{AS} = 13 A.

c. 1.6 mm from case.

d. $I_{SD} \leq I_D,$ starting T_J = 25 °C.

e. Limited by maximum junction temperature.

S16-1602-Rev. C, 15-Aug-16

1



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PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum Junction-to-Ambient	R _{thJA}	-		65				
Maximum Junction-to-Case (Drain)	R _{thJC}	- 3.8			°C/W			
× 7	1100							
SPECIFICATIONS ($T_J = 25 \ ^{\circ}C$, u	Inless otherw	ise noted)						
PARAMETER	SYMBOL	1	T CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static	L	•				•		
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} :	= 0 V, I _D = 250 μA		400	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	to 25 °C, I _D = 250) μA	-	0.53	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250 μA		3	-	5	V
Gate-Source Leakage	I _{GSS}		V _{GS} = ± 30 V		-	-	± 100	nA
			= 400 V, V _{GS} = 0 V		-	-	1	
Zero Gate Voltage Drain Current	IDSS	V _{DS} = 320 V	$V_{\rm H}, V_{\rm GS} = 0 V, T_{\rm J} = 7$	25 °C	-	-	10	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	$I_D = 5 A$		-	0.5	0.6	Ω
Forward Transconductance	g _{fs}	V _{DS}	s = 50 V, I _D = 5 A		-	2.7	-	S
Dynamic	L	•				•		
Input Capacitance	C _{iss}	V _{GS} = 0 V,		-	526	-		
Output Capacitance	C _{oss}		$V_{GS} = 0.0$, $V_{DS} = 100$ V,		-	59	-	1
Reverse Transfer Capacitance	C _{rss}	f = 1 MHz		-	9	-	1	
Effective Output Capacitance, Energy Related ^a	C _{o(er)}	V _{GS} = 0 V, V _{DS} = 0 V to 320 V		_	66	-	pF	
Effective Output Capacitance, Time Related ^b	C _{o(tr)}			-	84	-	1	
Total Gate Charge	Qg				-	15	30	
Gate-Source Charge	Q _{gs}	$V_{GS} = 10 V$	V _{GS} = 10 V I _D = 5 A, V _{DS} = 320 V		-	4	-	nC
Gate-Drain Charge	Q _{gd}			-	-	7	-	
Turn-On Delay Time	t _{d(on)}				-	12	24	
Rise Time	t _r		= 400 V, I _D = 10 A,	ľ	-	18	36	ns
Turn-Off Delay Time	t _{d(off)}		$= 10 \text{ V}, \text{ R}_{\text{q}} = 9.1 \Omega$		-	18	36	
Fall Time	t _f			ľ	-	14	28	1
Gate Input Resistance	R _g	f = 1	f = 1 MHz, open drain		0.9	1.8	3.6	Ω
Drain-Source Body Diode Characteristi	Ű							
Continuous Source-Drain Diode Current	١ _S	MOSFET sym showing the	MOSFET symbol showing the integral reverse p - n junction diode		-	-	10	
Pulsed Diode Forward Current	I _{SM}	•			-	-	40	A
Diode Forward Voltage	V _{SD}	T _J = 25 °	C, I _S = 5 A, V _{GS} =	0 V	-	-	1.2	V
Reverse Recovery Time	t _{rr}				-	230	-	ns
Reverse Recovery Charge	Q _{rr}	$T_J = 2$	T _J = 25 °C, I _F = I _S = 5 A, dl/dt = 100 A/ μ s ^{, V} _R = 25 V		-	1.6	-	μC
Reverse Recovery Current	I _{BBM}	ai/at =			-	14	_	A

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS} .

b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS} .

2

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SiHF10N40D

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

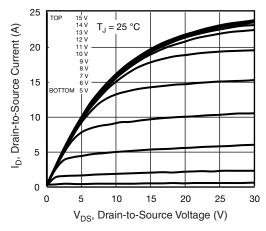


Fig. 1 - Typical Output Characteristics

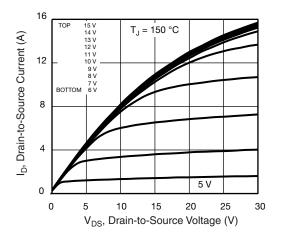


Fig. 2 - Typical Output Characteristics

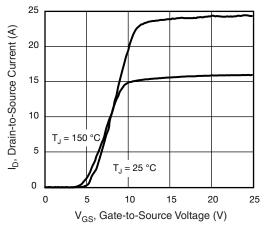


Fig. 3 - Typical Transfer Characteristics

S16-1602-Rev. C, 15-Aug-16

3 R_{DS(on)}, Drain-to-Source On Resistance (Normalized) 2.5 2 1.5 = 10 V GS 0.5 0 - 60 - 40 - 20 0 20 40 60 80 100 120 140 160 T_J, Junction Temperature (°C)

Fig. 4 - Normalized On-Resistance vs. Temperature

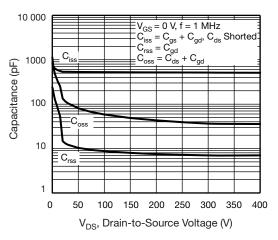
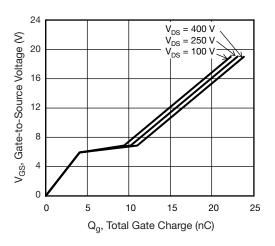


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage





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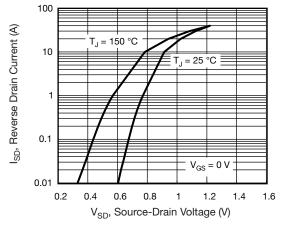


Fig. 7 - Typical Source-Drain Diode Forward Voltage

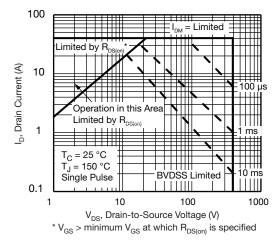


Fig. 8 - Maximum Safe Operating Area

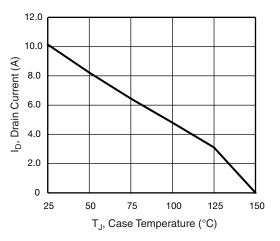


Fig. 9 - Maximum Drain Current vs. Case Temperature

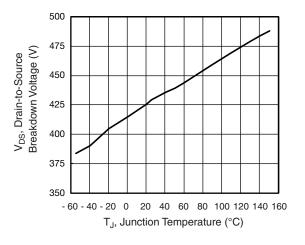
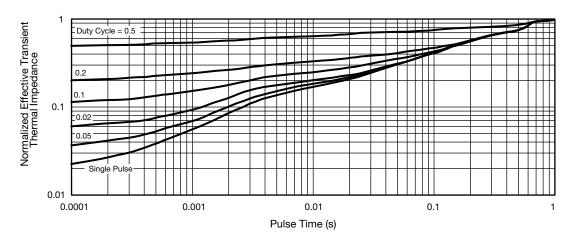
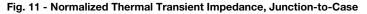


Fig. 10 - Temperature vs. Drain-to-Source Voltage





S16-1602-Rev. C, 15-Aug-16

4

Document Number: 91500

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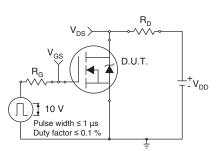


Fig. 12 - Switching Time Test Circuit

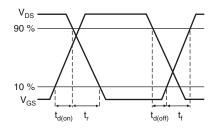


Fig. 13 - Switching Time Waveforms

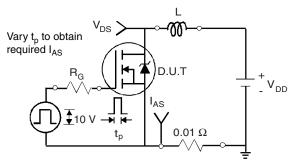


Fig. 14 - Unclamped Inductive Test Circuit

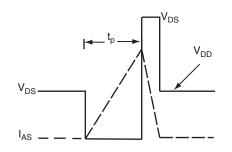
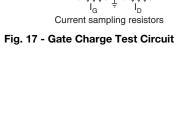


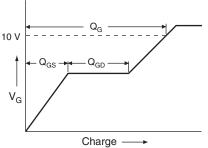
Fig. 15 - Unclamped Inductive Waveforms

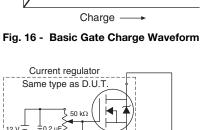
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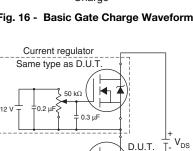


3 mA

V_{GS} >







H

Ί_D

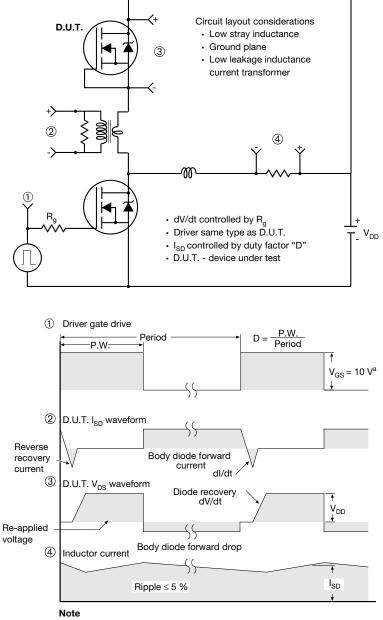
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Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5 V$ for logic level devices

Fig. 18 - For N-Channel

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S16-1602-Rev. C, 15-Aug-16	6	Document Number: 91500		
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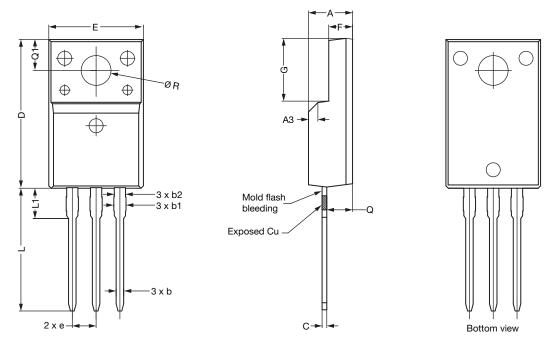
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TO-220 FULLPAK (High Voltage)

OPTION 1: FACILITY CODE = 9



		MILLIMETERS	
DIM.	MIN.	NOM.	MAX.
A	4.60	4.70	4.80
b	0.70	0.80	0.91
b1	1.20	1.30	1.47
b2	1.10	1.20	1.30
С	0.45	0.50	0.63
D	15.80	15.87	15.97
e		2.54 BSC	
E	10.00	10.10	10.30
F	2.44	2.54	2.64
G	6.50	6.70	6.90
L	12.90	13.10	13.30
L1	3.13	3.23	3.33
Q	2.65	2.75	2.85
Q1	3.20	3.30	3.40
ØR	3.08	3.18	3.28

Notes

- 1. To be used only for process drawing
- 2. These dimensions apply to all TO-220 FULLPAK leadframe versions 3 leads
- 3. All critical dimensions should C meet $C_{pk} > 1.33$
- 4. All dimensions include burrs and plating thickness
- 5. No chipping or package damage
 6. Facility code will be the 1st character located at the 2nd row of the unit marking

1

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OPTION 2: FACILITY CODE = Y



	MILLIN	MILLIMETERS		INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.		
А	4.570	4.830	0.180	0.190		
A1	2.570	2.830	0.101	0.111		
A2	2.510	2.850	0.099	0.112		
b	0.622	0.890	0.024	0.035		
b2	1.229	1.400	0.048	0.055		
b3	1.229	1.400	0.048	0.055		
С	0.440	0.629	0.017	0.025		
D	8.650	9.800	0.341	0.386		
d1	15.88	16.120	0.622	0.635		
d3	12.300	12.920	0.484	0.509		
E	10.360	10.630	0.408	0.419		
е	2.54	BSC	0.100 BSC			
L	13.200	13.730	0.520	0.541		
L1	3.100	3.500	0.122	0.138		
n	6.050	6.150	0.238	0.242		
ØP	3.050	3.450	0.120	0.136		
u	2.400	2.500	0.094	0.098		
V	0.400	0.500	0.016	0.020		

DWG: 5972

Notes

1. To be used only for process drawing

2. These dimensions apply to all TO-220 FULLPAK leadframe versions 3 leads

3. All critical dimensions should C meet $C_{pk} > 1.33$

4. All dimensions include burrs and plating thickness

5. No chipping or package damage

6. Facility code will be the 1st character located at the 2nd row of the unit marking

Revision: 08-Apr-2019

2

Document Number: 91359

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